16-bit buffer/line driver; 5 V input/output tolerant; 3-stateRev. 09 — 18 March 2010Product data sheet

### 1. General description

The 74LVC16244A; 74LVCH16244A are 16-bit non-inverting buffer/line drivers with 3-state bus compatible outputs. The device can be used as four 4-bit buffers, two 8-bit buffers or one 16-bit buffer. It features four output enable inputs,  $(1\overline{OE} \text{ to } 4\overline{OE})$  each controlling four of the 3-state outputs. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

The 74LVCH16244A bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

### 2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Multibyte flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance when V<sub>CC</sub> = 0 V
- All data inputs have bus hold. (74LVCH16244A only)
- Complies with JEDEC standard JESD8-B / JESD36
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



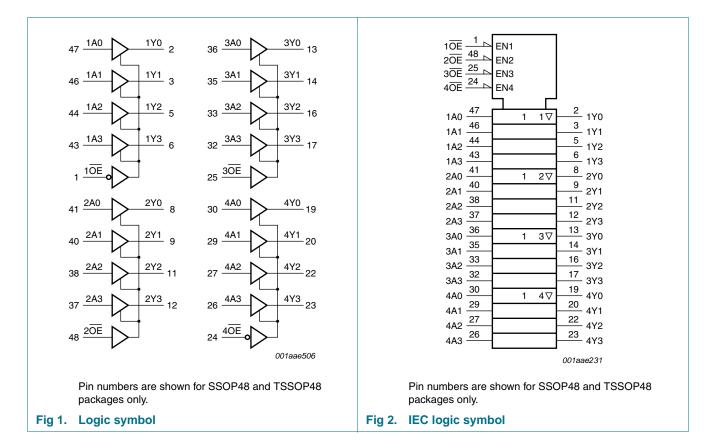
16-bit buffer/line driver; 5 V input/output tolerant; 3-state

## 3. Ordering information

Table 1.	Ordering	information
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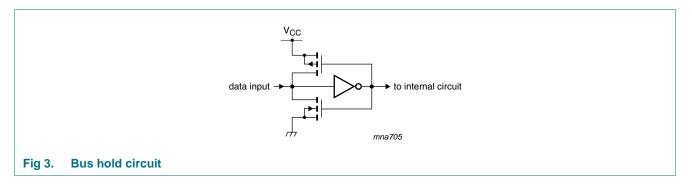
Type number	Temperature range	Package					
		Name	Description	Version			
74LVC16244ADL	–40 °C to +125 °C	SSOP48	plastic shrink small outline package; 48 leads;	SOT370-1			
74LVCH16244ADL			body width 7.5 mm				
74LVC16244ADGG	–40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package;	SOT362-1			
74LVCH16244ADGG			48 leads; body width 6.1 mm				
74LVC16244AEV	–40 °C to +125 °C	VFBGA56	plastic very thin fine-pitch ball grid array package;	SOT702-1			
74LVCH16244AEV			56 balls; body $4.5 \times 7 \times 0.65$ mm				
74LVC16244ABQ	–40 °C to +125 °C	HXQFN60U	plastic thermal enhanced extremely thin quad flat	SOT1134-1			
74LVCH16244ABQ			package; no leads; 60 terminals; UTLP based; body 4 x 6 x 0.5 mm				

### 4. Functional diagram

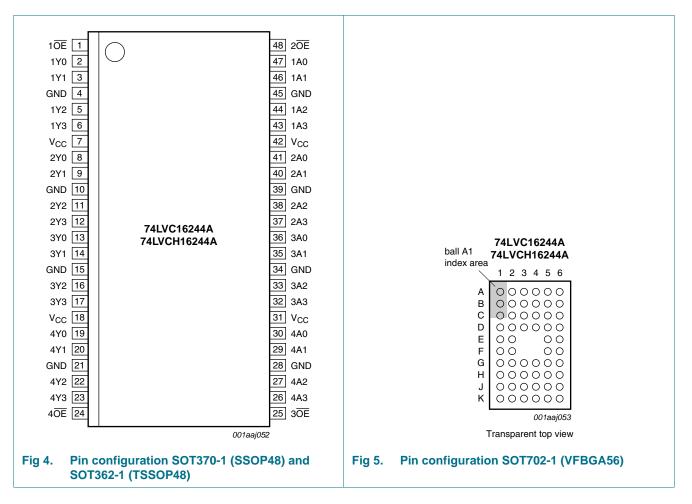


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16-bit buffer/line driver; 5 V input/output tolerant; 3-state

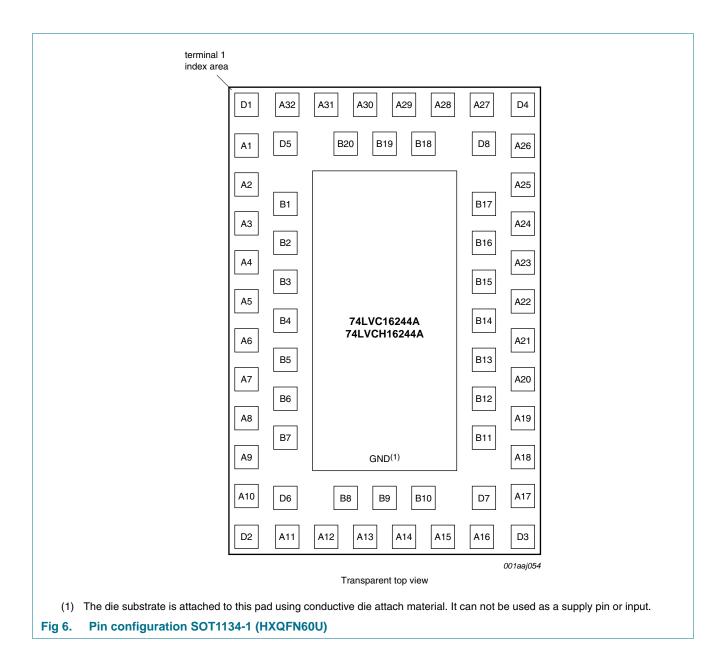


## 5. Pinning information



### 5.1 Pinning

16-bit buffer/line driver; 5 V input/output tolerant; 3-state



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# 74LVC16244A; 74LVCH16244A

16-bit buffer/line driver; 5 V input/output tolerant; 3-state

### 5.2 Pin description

. ...

Symbol	Pin			Description	
	SOT370-1 and SOT362-1	SOT702-1	SOT1134-1	-	
1 <u>0E</u> , 2 <u>0E</u> , 30E, 40E	1, 48, 25, 24	A1, A6, K6, K1	A30, A29, A14, A13	output enable input (active LOW	
1Y0 to 1Y3	2, 3, 5, 6	B2, B1, C2, C1	B20, A31, D5, D1	data output	
2Y0 to 2Y3	8, 9, 11, 12	D2, D1, E2, E1	A2, B2, B3, A5	data output	
3Y0 to 3Y3	13, 14, 16, 17	F1, F2, G1, G2	A6, B5, B6, A9	data output	
4Y0 to 4Y3	19, 20, 22, 23	H1, H2, J1, J2	D2, D6, A12, B8	data output	
GND	4, 10, 15, 21, 28, 34, 39, 45	B3, B4, D3, D4, G3, G4, J3, J4	A32, A3, A8, A11, A16, A19, A24, A27	ground (0 V)	
V <sub>CC</sub>	7, 18, 31, 42	C3, C4, H3, H4	A1, A10, A17, A26	supply voltage	
1A0 to 1A3	47, 46, 44, 43	B5, B6, C5, C6	B18, A28, D8, D4	data input	
2A0 to 2A3	41, 40, 38, 37	D5, D6, E5, E6	A25, B16, B15, A22	data input	
3A0 to 3A3	36, 35, 33, 32	F6, F5, G6, G5	A21, B13, B12, A18	data input	
4A0 to 4A3	30, 29, 27, 26	H6, H5, J6, J5	D3, D7, A15, B10	data input	
n.c.	-	A2, A3, A4, A5, K2, K3, K4, K5	A4, A7, A20, A23, B1, B4, B7, B9, B11, B14, B17, B19	not connected	

## 6. Functional description

#### Table 3.Function table<sup>[1]</sup>

Control	Input	Output
nOE	nAn	nYn
L	L	L
L	Н	Н
Н	Х	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

16-bit buffer/line driver; 5 V input/output tolerant; 3-state

## 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage	output HIGH or LOW	[2] -0.5	V <sub>CC</sub> + 0.5	V
		output 3-state	[2] -0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$ ;			
		(T)SSOP48 package	[3] _	500	mW
		VFBGA56 package	<u>[4]</u> _	1000	mW
		HXQFN60U package	<u>[4]</u> _	1000	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] Above 60 °C the value of  $P_{tot}$  derates linearly with 5.5 mW/K.

[4] Above 70 °C the value of  $P_{tot}$  derates linearly with 1.8 mW/K.

## 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

	Reconnicitation operating contain					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage	maximum speed performance	2.7	-	3.6	V
		functional	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW	0	-	V <sub>CC</sub>	V
		output 3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC}$ = 1.2 V to 2.7 V	0	-	20	ns/V
		$V_{CC}$ = 2.7 V to 3.6 V	0	-	10	ns/V

16-bit buffer/line driver; 5 V input/output tolerant; 3-state

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		<b>−40</b> ° <b>C</b>	c to +85	°C	–40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
Ин	HIGH-level input	V <sub>CC</sub> = 1.2 V		V <sub>CC</sub>	-	-	V <sub>CC</sub>	-	V
	voltage	$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level input	V <sub>CC</sub> = 1.2 V		-	-	0	-	0	V
	voltage	$V_{CC}$ = 2.7 V to 3.6 V		-	-	0.8	-	0.8	V
/ <sub>ОН</sub>	HIGH-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 2.7 \ V \text{ to } 3.6 \ V$		$V_{CC}-0.2$	V <sub>CC</sub>	-	$V_{CC}-0.3$	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$		2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$		2.4	-	-	2.25	-	V
		$I_{O}$ = -24 mA; $V_{CC}$ = 3.0 V		2.2	-	-	2.0	-	V
/ <sub>OL</sub>	LOW-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$							
VOI	voltage	$I_{O} = 100 \ \mu\text{A};$ $V_{CC} = 2.7 \ V \text{ to } 3.6 \ V$		-	0	0.20	-	0.3	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$		-	-	0.40	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$		-	-	0.55	-	0.8	V
I	input leakage current	$V_{\rm I}$ = 5.5 V or GND; $V_{\rm CC}$ = 3.6 V	[2]	-	±0.1	±5	-	±20	μA
OZ	OFF-state output current		<u>[2][3]</u>	-	±0.1	±5	-	±20	μΑ
OFF	power-off leakage current	$V_{\rm I}~\text{or}~V_{\rm O}$ = 5.5 V; $V_{CC}$ = 0.0 V		-	±0.1	±10	-	±20	μA
СС	supply current			-	0.1	20	-	80	μA
71 <sup>CC</sup>	additional supply current	per input pin; V <sub>I</sub> = V <sub>CC</sub> – 0.6 V; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 2.7 V to 3.6 V		-	5	500	-	5000	μA
Cı	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_I = GND \text{ to } V_{CC}$		-	5.0	-	-	-	pF
BHL	bus hold LOW current	$V_{CC} = 3.0 \text{ V}; \text{ V}_{I} = 0.8 \text{ V}$	<u>[4][5]</u>	75	-	-	60	-	μA
BHH	bus hold HIGH current	$V_{CC} = 3.0 \text{ V}; \text{ V}_{I} = 2.0 \text{ V}$	<u>[4][5]</u>	-75	-	-	-60	-	μA
BHLO	bus hold LOW overdrive current	V <sub>CC</sub> = 3.6 V	<u>[4][6]</u>	500	-	-	500	-	μA

### **NXP Semiconductors**

# 74LVC16244A; 74LVCH16244A

#### 16-bit buffer/line driver; 5 V input/output tolerant; 3-state

#### Table 6. Static characteristics ... continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	nditions -40 °C to +85 °C -		–40 °C to +125 °C		Unit		
				Min	Typ[1]	Max	Min	Max	
I <sub>BHHO</sub>	bus hold HIGH overdrive current	V <sub>CC</sub> = 3.6 V	[4][6]	-500	-	-	-500	-	μA

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

[2] The bus hold circuit is switched off when  $V_I > V_{CC}$  allowing 5.5 V on the input terminal.

[3] For I/O ports the parameter I<sub>OZ</sub> includes the input leakage current.

[4] Valid for data inputs of bus hold parts only (74LVCH16244A). Note that control inputs do not have a bus hold circuit.

[5] The specified sustaining current at the data input holds the input below the specified V<sub>1</sub> level.

[6] The specified overdrive current at the data input forces the data input to the opposite input state.

## **10. Dynamic characteristics**

#### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 9</u>.

Symbol	Parameter	Conditions		- <b>40</b>	40 °C to +85 °C –40 °C to +125 °C		o +125 °C	Unit	
				Min	Тур	Max	Min	Max	
t <sub>pd</sub>	propagation	nAn to nYn; see Figure 7	<u>[1]</u>						
C	delay	V <sub>CC</sub> = 1.2 V		-	11.0	-	-	-	ns
		$V_{CC} = 2.7 V$		1.0	-	4.7	1.0	6.0	ns
		$V_{CC}$ = 3.0 V to 3.6 V	[2]	1.1	3.0	4.1	1.1	5.5	ns
t <sub>en</sub> enable time	n <mark>OE</mark> to nYn; see <u>Figure 8</u>	<u>[1]</u>							
		V <sub>CC</sub> = 1.2 V		-	15.0	-	-	-	ns
		$V_{CC} = 2.7 V$		1.0	-	5.8	1.0	7.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V	[2]	1.0	3.5	4.6	1.0	6.0	ns
t <sub>dis</sub>	disable time	n <mark>OE</mark> to nYn; see <u>Figure 8</u>	<u>[1]</u>						
		V <sub>CC</sub> = 1.2 V		-	10.0	-	-	-	ns
		$V_{CC} = 2.7 V$		1.0	-	6.2	1.0	8.0	ns
		$V_{CC}$ = 3.0 V to 3.6 V	[2]	1.8	3.7	5.2	1.8	6.5	ns

### 16-bit buffer/line driver; 5 V input/output tolerant; 3-state

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 9</u> .									
Symbol	Parameter	Conditions	-40 °C to +85 °C -40			-40 °C to	−40 °C to +125 °C		
			Min	Тур	Max	Min	Мах		
C <sub>PD</sub> power		per buffer; $V_I = GND$ to $V_{CC}$ ; $V_{CC} = 3.3 V$ [3]							
	dissipation capacitance	outputs enabled	-	12	-	-	-	pF	
	capacitance	outputs disabled	-	4.0	-	-	-	pF	

#### Table 7. Dynamic characteristics ... continued

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

ten is the same as tPZL and tPZH.

 $t_{\text{dis}}$  is the same as  $t_{\text{PLZ}}$  and  $t_{\text{PHZ}}.$ 

[2] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 3.3 V.

[3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

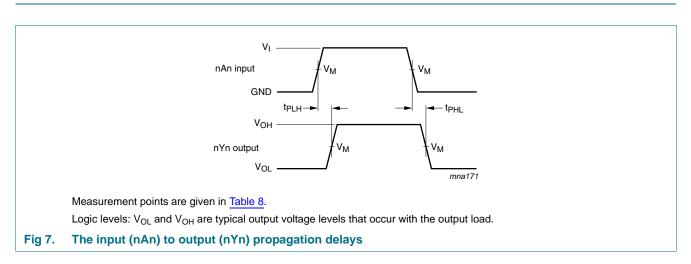
C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

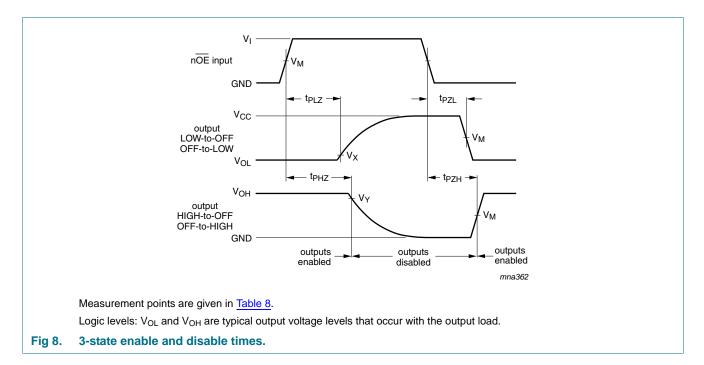
N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$  = sum of the outputs.

### 11. Waveforms



16-bit buffer/line driver; 5 V input/output tolerant; 3-state



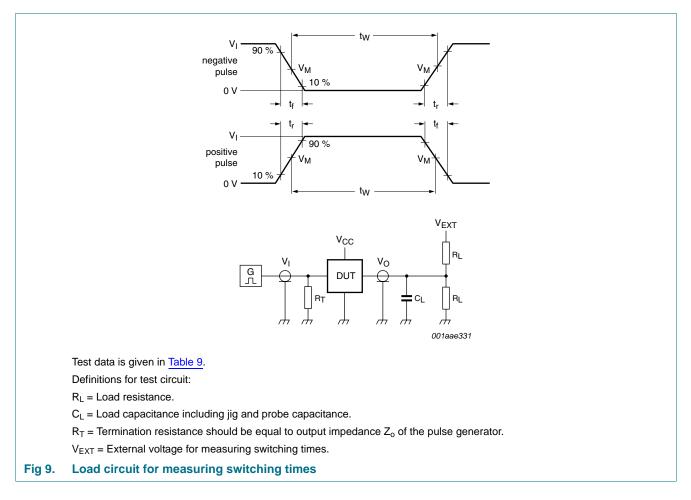
#### Table 8. Measurement points

Supply voltage	Input		Output			
V <sub>CC</sub>	VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>	
1.2 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.1 V	V <sub>OH</sub> – 0.1 V	
2.7 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 \ V$	
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V	

### **NXP Semiconductors**

# 74LVC16244A; 74LVCH16244A

16-bit buffer/line driver; 5 V input/output tolerant; 3-state



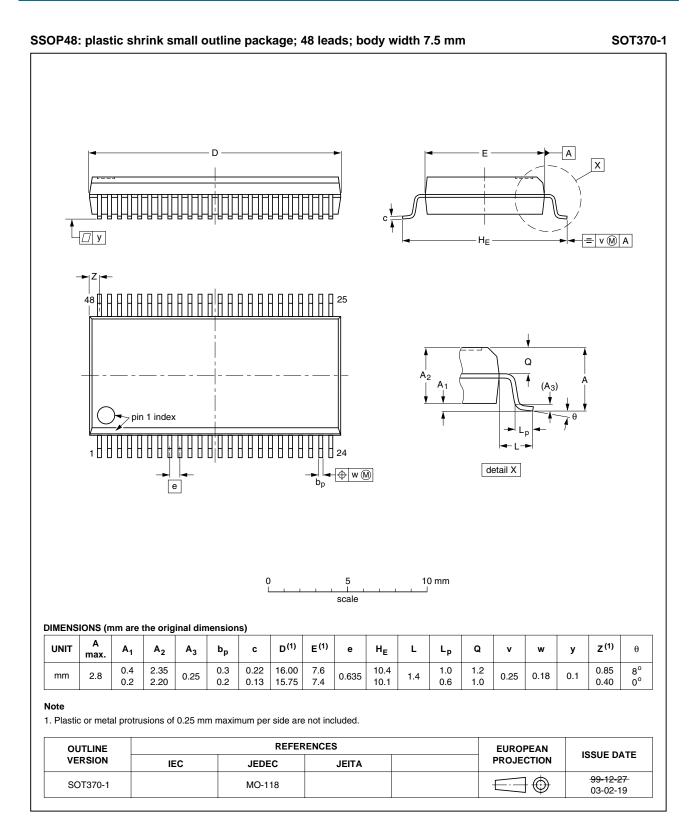
	Tab	le 9.	Test	data
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Supply voltage	Input		Load		V <sub>EXT</sub>		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>
1.2 V	V <sub>CC</sub>	$\leq$ 2.5 ns	50 pF	500 Ω <mark>[1]</mark>	open	$2\times V_{CC}$	GND
2.7 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND
3.0 V to 3.6 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND

[1] The circuit performs better when  $R_L = 1 \ k\Omega$ .

16-bit buffer/line driver; 5 V input/output tolerant; 3-state

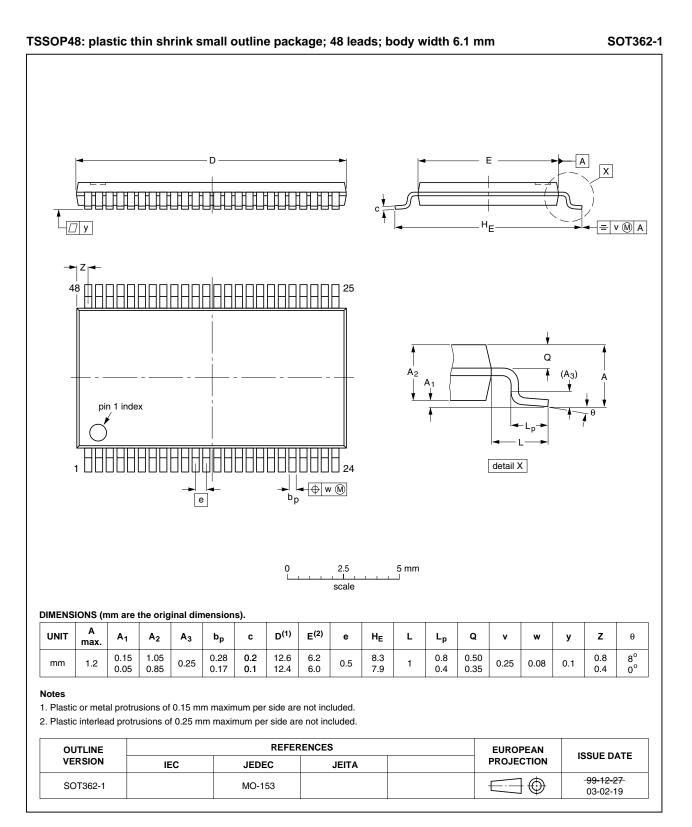
## 12. Package outline



#### Fig 10. Package outline SOT370-1 (SSOP48)

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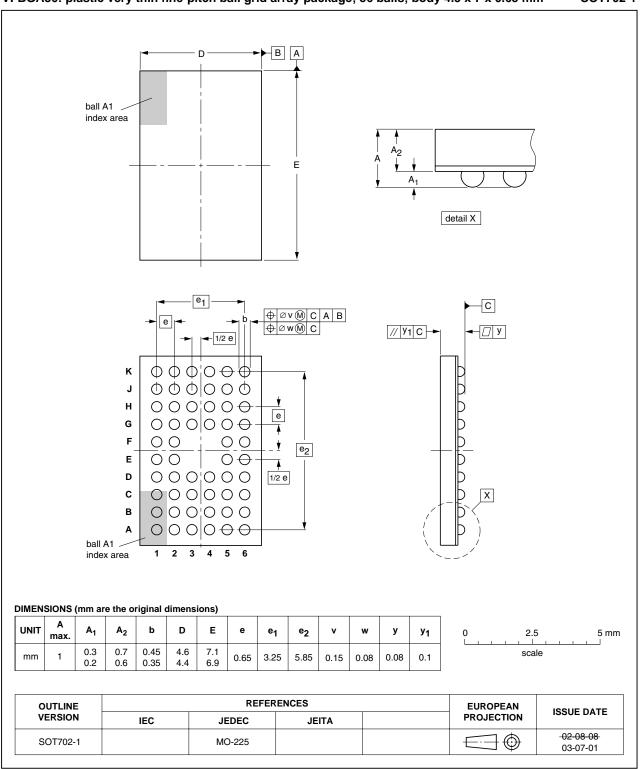
16-bit buffer/line driver; 5 V input/output tolerant; 3-state



#### Fig 11. Package outline SOT362-1 (TSSOP48)

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16-bit buffer/line driver; 5 V input/output tolerant; 3-state

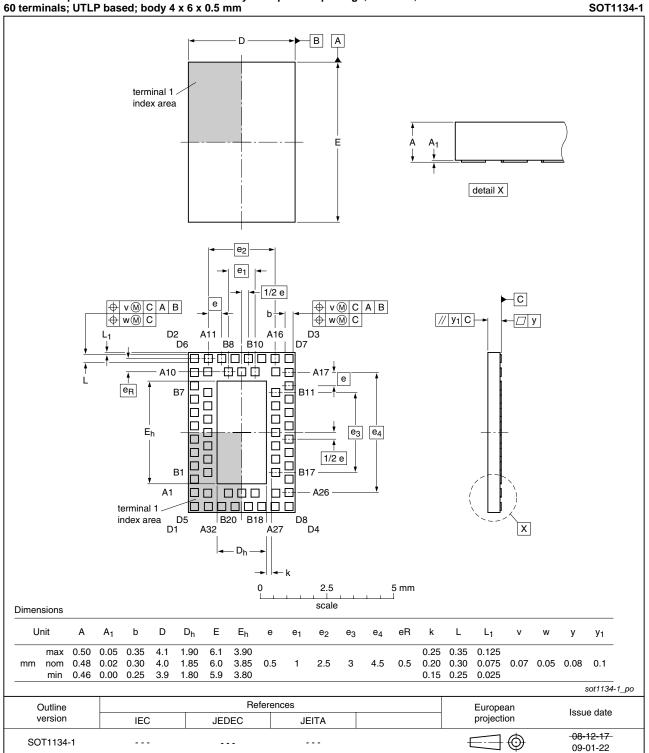


VFBGA56: plastic very thin fine-pitch ball grid array package; 56 balls; body 4.5 x 7 x 0.65 mm SOT702-1

#### Fig 12. Package outline SOT702-1 (VFBGA56)

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16-bit buffer/line driver; 5 V input/output tolerant; 3-state



HXQFN60U: plastic thermal enhanced extremely thin quad flat package; no leads; 60 terminals; UTLP based; body 4 x 6 x 0.5 mm

#### Fig 13. Package outline SOT1134-1 (HXQFN60U)

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16-bit buffer/line driver; 5 V input/output tolerant; 3-state

## 13. Abbreviations

Table 10. Abbreviations			
Acronym	Description		
CMOS	Complementary Metal Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
HBM	Human Body Model		
MM	Machine Model		
TTL	Transistor-Transistor Logic		

## 14. Revision history

Table 11. Revision histor	у			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH16244A_9	20100318	Product data sheet	-	74LVC_LVCH16244A_8
Modifications:		BQ and 74LVCH16244Al OT1134-1) package.	BQ changed from HL	JQFN60U (SOT1025-1) to
74LVC_LVCH16244A_8	20081117	Product data sheet	-	74LVC_LVCH16244A_7
74LVC_LVCH16244A_7	20031208	Product specification	-	74LVC_LVCH16244A_6
74LVC_LVCH16244A_6	20030130	Product specification	-	74LVC_LVCH16244A_5
74LVC_LVCH16244A_5	20021030	Product specification	-	74LVC_H16244A_4
74LVC_H16244A_4	19971028	Product specification	-	74LVC16244A_ 74LVCH16244A_3
74LVC16244A_ 74LVCH16244A_3	19971028	Product specification	-	74LVC16244A_2
74LVC16244A_2	19970630	Product specification	-	74LVC16244A_1
74LVC16244A_1	-	-	-	-

16-bit buffer/line driver; 5 V input/output tolerant; 3-state

## **15. Legal information**

#### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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16-bit buffer/line driver; 5 V input/output tolerant; 3-state

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### **NXP Semiconductors**

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16-bit buffer/line driver; 5 V input/output tolerant; 3-state

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Date of release: 18 March 2010 Document identifier: 74LVC\_LVCH16244A\_9